

Search Notes

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	2	("5872493").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 09:54
L3	0	("self-supportingadjcoverandsemiconductor").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 09:55
L4	1	self-supporting adj cover and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 09:55
L5	1245	(257/701).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 09:57
L6	242	baw with filter	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 09:57
L7	2543	(257/678).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 09:57
L8	0	L7 and L6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 09:59
L9	8892	saw with filter	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:11
L10	1260	(257/704).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 09:59

L11	19	9 and L10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:08
L12	1	"6638654".PN.	USPAT; USOCR	OR	ON	2005/10/03 10:03
L13	1	"6612535".PN.	USPAT; USOCR	OR	ON	2005/10/03 10:03
L14	1	"20040067407".PN.	US-PGPUB	OR	ON	2005/10/03 10:03
L15	1	"20020043895".PN.	US-PGPUB	OR	ON	2005/10/03 10:04
L16	1	"6326682".PN.	USPAT; USOCR	OR	ON	2005/10/03 10:04
L17	1	"5164558".PN.	USPAT; USOCR	OR	ON	2005/10/03 10:04
L18	22	"5422615"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:09
L19	10	saw with filter and plastic and hollow and mems	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:13
L20	1296	filter and plastic and hollow and mems	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:13
L21	360	filter and plastic and hollow and mems and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:15
L22	341	filter and plastic and hollow and mems and semiconductor and contact	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:16
L23	50	filter and plastic and hollow and mems and semiconductor and external with contact	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:17
L24	1	(baw or saw) with filter and plastic and hollow and mems and semiconductor and external with contact	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:21

L25	0	(2002/0006588).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 10:21
L26	2	("20020006588").PN	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 10:21
L28	76	L10 and mems	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 10:23
S1	240	baw with filter	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 09:59
S2	2305	wafer with level with package	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/22 22:03
S3	4	S1 and S2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/22 22:02
S4	194	wafer with level with package and filter	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 09:42
S5	22	wafer with level with package and if same filter	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/22 22:07
S6	1255	(257/704).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/03 10:22
S7	0	("006and1").PN	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/22 22:07

S8	1	S6 and S1	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/03 09:57
S10	2532	(257/678).CCIS	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/22 22:12